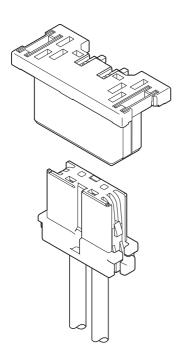


LEX CONNECTOR



2.5mm pitch/For LED Lamp/Disconnectable Crimp style connectors



Considering about luminescence property of LED package, this LEX connector is designed as low profile bottom type connector for LED lighting equipment, and achieves the space saving at the connector mounting side.

In consideration of connector mating operation, secure lock and mechanism for preventing wrong insertion are provided. With the assumption that the load may be applied to the soldering part when mating the connector, the strength of soldering part after mounting the connector on PCB has been largely improved.

- Low profile and space saving design
 Mounting height at connector mounting side: 1.2mm
- Secure locking mechanism
- Mechanism for preventing wrong insertion
- Halogen-free and RoHS compliant

Specifications -

• Current rating: 3A AC, DC (AWG #22)

• Voltage rating: 300V AC, DC

• Temperature range: -55°C to +105°C

(including temperature rise in applying

electrical current)

• Contact resistance: Initial value/ 10m Ω max.

After environmental testing/20m Ω max.

• Insulation resistance: 1,000M Ω min.

• Withstanding voltage: 1,700V AC/minute

• Applicable wire: Conductor size/ AWG #30 to #22

Insulation O.D./0.7 to 1.3mm

* Compliant with RoHS.

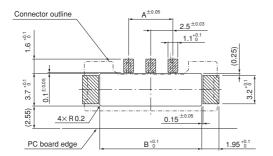
* Refer to "General Instruction and Notice when using Terminals and Connectors" at the end of this catalog.

* Contact JST for details.

Standards -

Recognized E60389

G: Certified LR20812



	7	<u>!</u>
		(7.5)

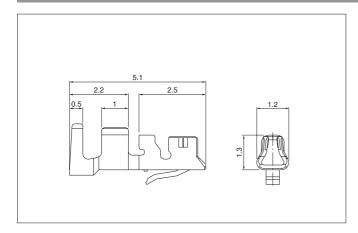
	Circuits	Dimensions (mm)		
	Circuits	Α	В	
	2	_	9.0	
	4	7.5	14.0	

Note: 1. The above figure is the figure viewed from the connector mounting side.

2. Tolerances are non-cumulative: ±0.05mm for all centers.
The dimensions above should serve as a guideline. Contact JST for details.

LEX CONNECTOR

Contact



Model No.		Q'ty /			
woder No.	mm²	AWG#	Insulation O.D. (mm)	reel	
SSFH-001T-P0.5	0.13~0.33	26~22	0.95~1.3	15,000	
SSFH-002T-P0.5	0.05~0.13	30~26	0.7 ~1.25	15,000	

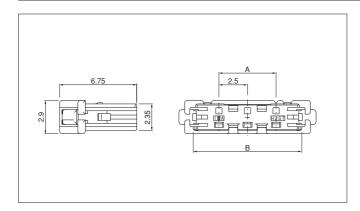
Material and Finish

Copper alloy, tin-plated (reflow treatment)

RoHS compliance

	Crimping	Applicator			
Contact	machine	Crimp applicator	Dies	Crimp applicator with dies	
SSFH-001T-P0.5).5 AP-K2N	MKS-L	MK/SSFH-001-05	APLMK SSFH001-05	
33FH-0011-F0.5		_	_	_	
SSFH-002T-P0.5	AP-K2N	MKS-L	MK/SSFH-002-05	APLMK SSFH002-05	
33FH-0021-P0.3		_	_	_	

Housing



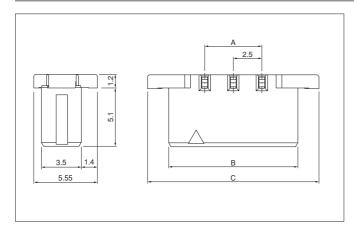
Ci	Circuito	Model No.	Dimension	Q'ty /	
	Circuits		Α	В	bag
	2	LEXR-02V-S(HF)	_	7.0	2,000
	4	LEXR-04V-S(HF)	7.5	12.0	1,000

Material

Glass-filled PA 66, UL94V-0, natural

RoHS compliance

Shrouded header



Circuits	Model No.	Dimensions (mm)			Q'ty /
		Α	В	С	reel
2	EM02B-LEXSS-TF(HF)	_	8.8	12.5	1,600
4	EM04B-LEXSS-TF(HF)	7.5	13.8	17.5	1,600

Material and Finish

Press pin: Copper alloy, copper-undercoated, tin-plated (reflow treatment) Housing: PA 9T, UL94V-0, natural

Solder tab: Copper alloy, copper-undercoated, tin-plated (reflow treatment)

RoHS compliance

Note: The products listed above are supplied on embossed-tape.